RUMENTS Data sheet acquired from Harris Semiconductor SCHS083

# CD4536B Types

### **CMOS Programmable Timer**

High-Voltage Types (20-Volt Rating)

CD4536B is a programmable timer consisting of 24 ripple-binary counter stages. The salient feature of this device is its flexibility. The device can count from 1 to  $2^{24}$  or the first 8 stages can be bypassed to allow an output, selectable by a 4-bit code, from any one of the remaining 16 stages. It can be driven by an external clock or an RC oscillator that can be constructed using onchip components. Input IN1 serves as either the external clock input or the input to the on-chip RC oscillator. OUT1 and OUT2 are connection terminals for the external RC components. In addition, an on-chip monostable circuit is provided to allow a variable pulse width output. Various timing functions can be achieved using combinations of these capabilities.

A logic 1 on the 8-BYPASS input enables a bypass of the first 8 stages and makes stage 9 the first counter stage of the last 16 stages. Selection of 1 of 16 outputs is accomplished by the decoder and the BCD inputs A, B, C and D. MONO IN is the timing input for the on-chip monostable oscillator. Grounding of the MONO IN terminal through a resistor of 10K ohms or higher, disables the one-shot circuit and connects the decoder directly to the DECODE OUT terminal. A resistor to VDD and a capacitor to ground from the MONO IN terminal enables the one-shot circuit and controls its pulse width.

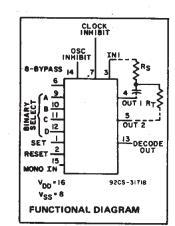
A fast test mode is enabled by a logic 1 on 8-BYPASS, SET, and RESET. This mode

### Features:

- = 24 flip-flop stages -- counts from 2° to 224
- Last 16 stages selectable by BCD select code.
- Bypass input allows bypassing first 8 stages
- On-chip RC oscillator provision
- Clock inhibit input
- Schmitt-trigger in clock line permits operation with very long rise and fall times
- On-chip monostable output provision
- Typical f<sub>CL</sub> = 3 MHz at V<sub>DD</sub> = 10 V
- Test mode allows fast test sequence
- Set and reset inputs
- Capable of driving two low power TTL loads, one lower-power Schottky load, or two HTL loads over the rated temperature rance
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

divides the 24-stage counter into three 8-stage sections to facilitate a fast test sequence.

The CD4536B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix)," and in chip form (H suffix).



### **RECOMMENDED OPERATING CONDITIONS**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIN	UNITS	
	Min.	Max.	
Supply-Voltage Range (For T <sub>A</sub> = Full Package Temperature			
Range)	3	18	v

3

COMMERCIAL CMOS HIGH VOLTAGE ICs

### DECODE OUT SELECTION TABLE

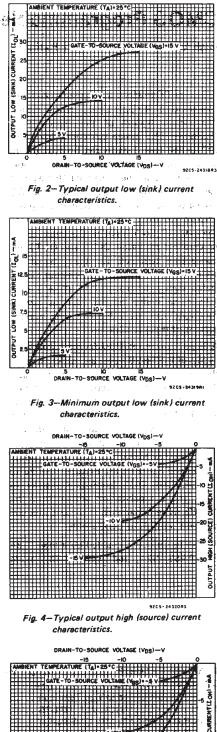
_	_							
D	с	в	Δ	NUMBER OF STAGES IN DIVIDER CHAIN				
				8-BYPASS = 0	8-BYPASS = 1			
0	0	0	0	9	1			
0	0	0	1	10	2			
0	0	1	0	11	3			
0	0	1	1	12	4			
0	1	0	0	13	5			
0	1	0	1	. 14	6			
0	1	1	0	15	7			
0	1	1	1	16	8			
1	0	0	0	17	9			
1	0	0	1	18	10			
1	0	1	0	19	11			
1	0	1	1	20	12			
1	1	0	0	21	13			
1	1	0	1	22	14			
1	1	1	0	23	15			
1	1	1	1	24	16			

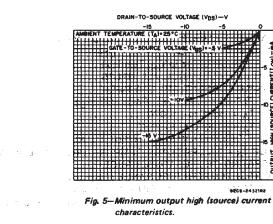
1 = High Level 0 = Low Level

MAXIMUM RATINGS, Absolute-Maximum Values:
DC SUPPLY-VOLTAGE RANGE, (VDD)
Voltages referenced to VSS Terminal)
INPUT VOLTAGE RANGE, ALL INPUTS0.5V to VDD +0.5V
DC INPUT CURRENT, ANY ONE INPUT ±10mA
POWER DISSIPATION PER PACKAGE (PD):
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$
For T <sub>A</sub> = +100°C to +125°C Derate Linearity at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) 100mW
OPERATING-TEMPERATURE RANGE (TA)55°C to +125°C
STORAGE TEMPERATURE RANGE (Tsig)65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):

### STATIC ELECTRICAL CHARACTERISTICS

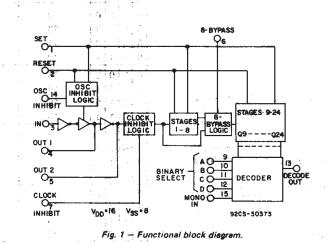
CHARAC- TERISTIC	CON	DITIO	NS	LIM	ITS AT II	NDICATE	ED TEMI	PERATU	IRES (°C	) )	U N I T
	Vo (V)	NIN NIN	V <sub>DD</sub> (V)	-55	-40	+85	+125	Min.	+25 Typ.	Max.	S
		0,5	5	5	5	150	150	_	0.04	5	
Quiescent Device		0,10	10	10	10	300	300	-	0.04	10	μА
Current,	_	0,15	15	20	20	600	600		0.04	- 20	1
IDD Max.	-	0,20	20	100	100	3000	3000	``	40.08	100	. w
Output Low 0.4 0.5 5 0.64 0.61 0.42 0.36 0.5		0.51	1								
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	- 1	
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	1. <del>-</del> 1.	1
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6		1 ·
<sup>I</sup> OH <sup>Min</sup>	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	ŀ
Output Voltage:	-	0,5	5		0	.05		-	0	0.05	-
Low-Level,	_	,0,10	10		0	.05	,	1 <u>-</u> 1	0	0.05	]
VOL Max.	· · ·	.0,15	15		0	.05			0	0.05	] v [
Output	· · _ ·	0,5	5		4	.95	- 11	4.95	5 5	-	
Voltage: High-Level,	-	0,10	10		9	95	1997 - A.	9.95	iii. 10		
V <sub>OH</sub> Min.		.0,15	15		14	95	* **	14.95	15	-	- mA - 0.05 0.05 0.05 v
Input Low	0.5,4.5	-	5			1.5		-	-	1.5	
Voltage	1,9	_	10			3			· · –	3	]
VIL Max.	1.5,13.5	<u> </u>	15			4				4	l v
Input High	0.5,4.5	-	5		÷	3.5		3.5	-	-	
Voltage,	1,9	-	10			. 7		7	–		
V <sub>IH</sub> Min.	1.5,13.5	-	15			11		- 11	-	-	
Input Current I <sub>IN</sub> Max.		0,18	18	±0.1	±0.1	±1	±1 ,		±10 <sup>-5</sup>	±0.1	۸ц





SOURCEI

output



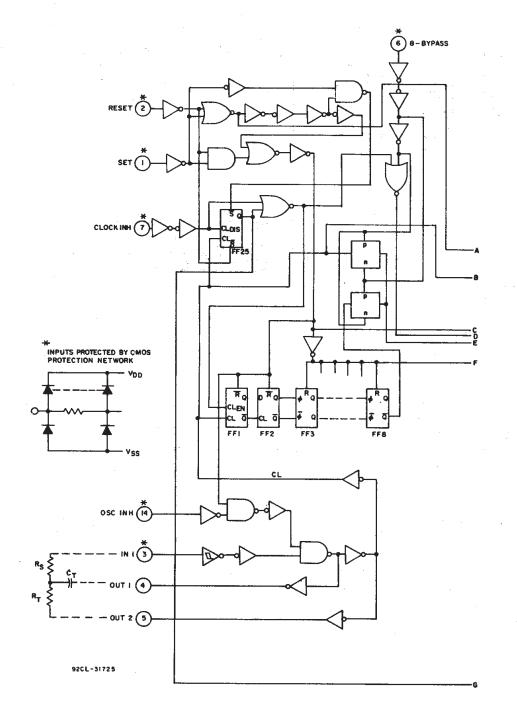


Fig.6 - Logic diagram for CD4536B [continued on next page].

NOTE: 
$$f \approx \frac{1}{3R_T C_T}$$
,  $R_S \approx (5 \rightarrow 10) \times R_T$ 

3 COMMERCIAL CMOS HIGH VOLTAGE ICs

CD4536B Types

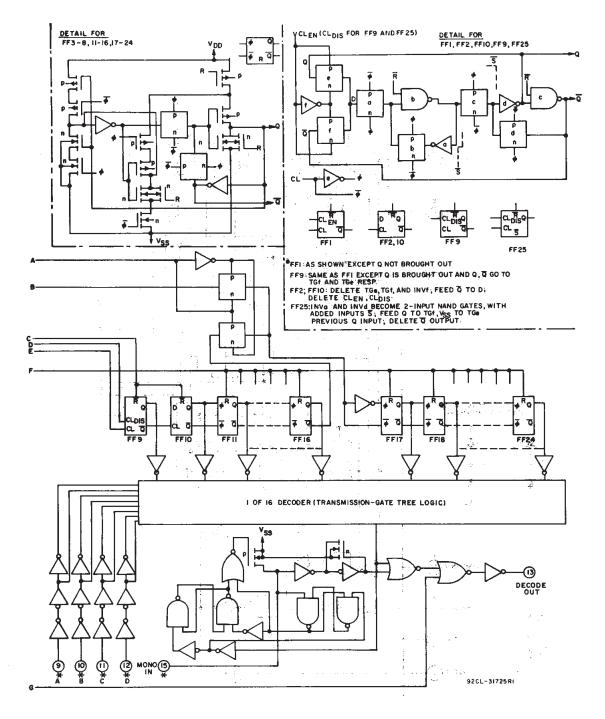


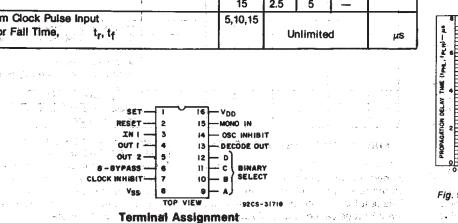
Fig.6 - Logic diagram for CD4536B [continued from previous page].

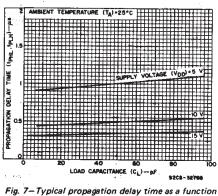
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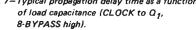
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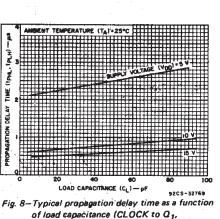
## **DYNAMIC ELECTRICAL CHARACTERISTICS,** at $T_A = 25$ °C, Input $t_r$ , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ kQ

CHARACTERISTIC	VDD	<u> </u>	LIMITS		
	N.	Min.	Тур.	Max.	UNITS
Propagation Delay Times:	- 5	-	1	2	
Clock to Q1, 8-Bypass High	10	_	0.5	1	μs
tPHL, tPLH	15	• • • <u>-</u> •	0.35	0.7	
Clock to Q1, 8-Bypass Low	5			5	
tPHL, tPLH	10			-	, μş
	15	_			
Clock to Q16, TPHL tPLH	.5		1		
					μs
	15	_		-	μο
Q <sub>n</sub> to Q <sub>n + 1</sub> , t <sub>PHL</sub> , t <sub>PLH</sub>	5		150	— <u> </u>	
	-		1		ns
	(V) Min. Typ. Max.   5  1 2   10  0.5 1   15  0.5 1   5  2.5 5   10  0.8 1.6   15  0.6 1.2   tPLH 5  4 8   10  1.5 3 15   tPLH 5  1 2   tPLH 5  150 300   10  75 150   15  300 600   10  125 250   15  30 6   10  1 2   10  1 2   15  30 6   10  50 100   15 - 200	113			
Set to Q <sub>n</sub> , t <sub>PLH</sub>		<u>                                     </u>			
		-			
		Γ. Ξ. C			ាទ
Reset to Q <sub>n</sub> , t <sub>PHL</sub>					
THOSE TO WITH THE PHL	- <u>+</u>	-			
	1 1 1 1 1 1 1 1	1. <u> </u>	F 1 5	_	μS
Transition Time, tTHL, tTLH					
THL, TLH	-	1.1.1	1		
		-			ns
Minimum Pulse Widths:					
Clock	-	-			
		-	1.1.1.1.1.1.1		ns
Set					
Set	-				
		-			ns
Reset					
,		<b> </b> —	· ·		μs
Minimum Set Recovery Time,		-	1.1.1		
a de la companya de la		[	1 1 1	_	μS
and a second	15		0.6	1.6	
Minimum Reset Recovery Time,		—			
					μS
: 				2	- E 1
Maximum Clock Pulse Input		· · · ·	1 T 1	-	
Frequency, f <sub>CL</sub>			-	-	MHz
	15	2.5	5	—	L
Maximum Clock Pulse Input	5,10,15				
Rise or Fall Time, t <sub>r</sub> , t <sub>f</sub>		U V	nlimited	t I	μS

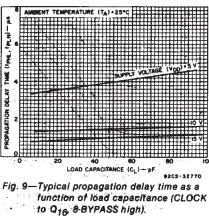








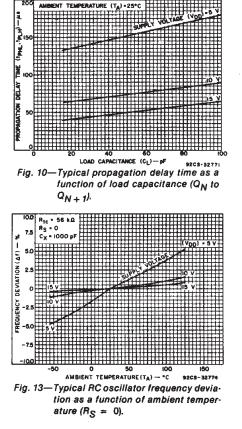
of load capacitance (CLOCK to 8-BYPASS low).

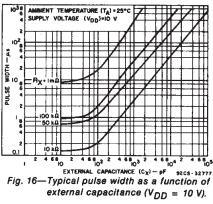


3

COMMERCIAL CMOS HIGH VOLTAGE ICS

### CD4536B Types





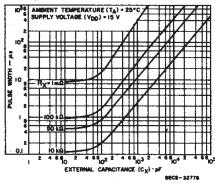
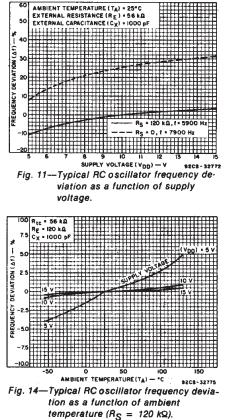


Fig. 17—Typical pulse width as a function of external capacitance (V<sub>DD</sub> = 15 V).



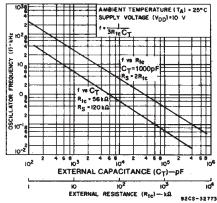


Fig. 12—Typical RC oscillator frequency deviation as a function of time constant resistance and capacitance.

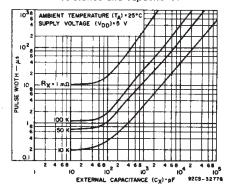


Fig. 15—Typical pulse width as a function of external capacitance (V<sub>DD</sub> = 5 V).

	Functional Test Sequence								
inputs				Outputs	Comments				
In <sub>1</sub> Set Reset		8-Bypass	Decode Out Q1 thru Q24	All 24 steps are in Reset mode					
_ 1	0	1	. 1	0	]				
1	1	1 .	1	0	Counter is in three 8-stage section in parallel mode				
0	1	1	1	0	First "1" to "0" transition of clock				
1 0 	1	1	1		255 "1" to "0" transitions are clocked in the counter				
0	1	1	1	1	The 255 "1" to "0" transition				
0	0	0	0	1	Counter converted back to 24 stages in series mode Set and Reset must be connected together and simultaneously go from "1" to "0"				
1	0	0	0	1	In 1 Switches to a "1"				
0	0	0	0	0	Counter Ripples from an all "1" state to an all "0" state				

#### FUNCTIONAL TEST SEQUENCE

Test Function (Figure 23) has been included for the reduction of test time required to exercise all 24 counter stages. This test function divides the counter into three 8-stage sections and 255 counts are loaded in each of the 8-stage sections in parallel. All flip-flops are now at a "1". The counter is now returned to the normal 24-steps in series configuration. One more pulse is entered into  $ln_1$  which will cause the counter to ripple from an all "1" state to an all "0" state.

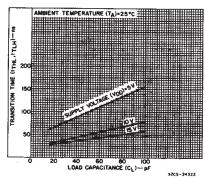
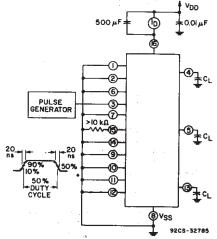
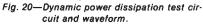
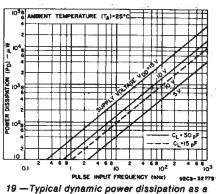
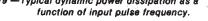


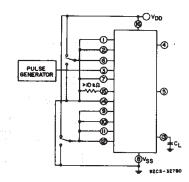
Fig. 18—Typical transition time as a function of load capacitance.



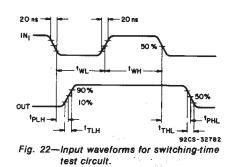








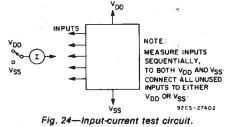




(G<sup>VDD</sup> ۲ PULSE ര ଡ ß -6) П ා 0 ø (\$vss 92C3-32786 Fig. 23—Functional test circuit.

3

COMMERCIAL CMOS HIGH VOLTAGE ICS



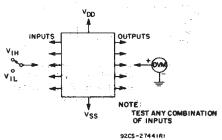
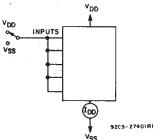
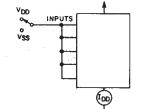


Fig. 25-Input-voltage test circuit.







vss

Fig. 26—Quiescent-device current test circuit.



IN1	SET	RESET	CLOCK INH	OSC INH	OUT1	OUT2	DECODE OUT
<u></u>	0	0	0	. 0	$\int$	$\overline{}$	No Change
	0	0	-0	0			Advance to Next State
X	1	0	0			1	- 1
X	0	i sa si si	0	0	0	1	· · · · · · · · · · · · · · · · · · ·
x	0	0	1	0			No Change
0	0	.0	0	×	0	1	No Change
1	0	0	0	5			Advance to Next State

3-317

### CD4536B Types

### **APPLICATIONS**

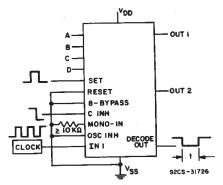


Fig. 27—Time interval configuration using external clock; set and clock inhibit functions.

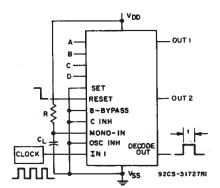


Fig. 28—Time interval configuration using external clock; reset and output monostable to achieve a pulse output.

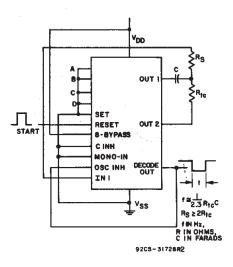
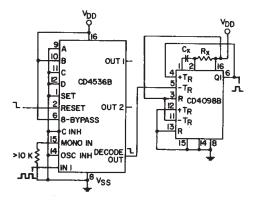


Fig. 29—Time interval configuration using onchip RC oscillator and reset input to initiate time interval.



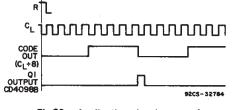


Fig.30 – Application showing use of CD4098B and CD4536B to get decode pulse 8 clock pulses after Reset pulse.

Dimensions and pad layout for CD4536BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).

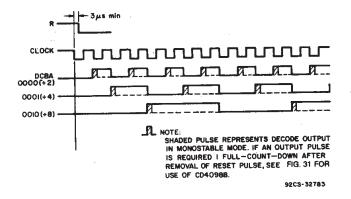
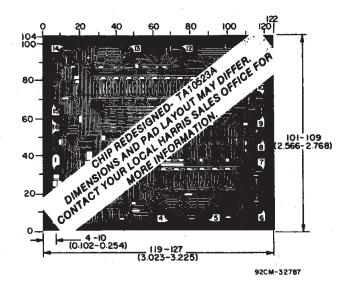


Fig.31 -- CD4536B Timing Diagram.



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